

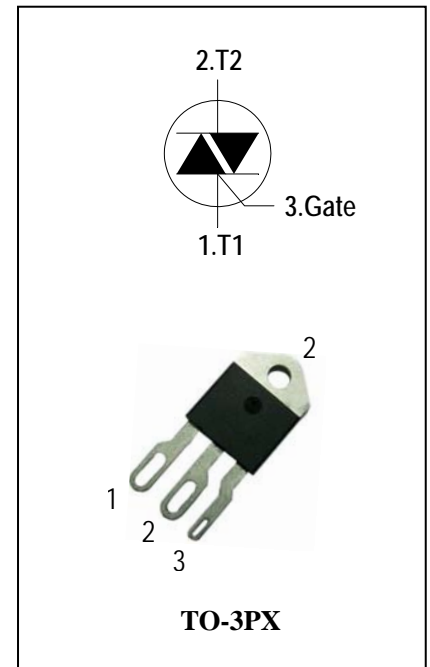
## 3 Quadrants Triacs

### General Description

High current density due to mesa technology .the ADS40C triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, High power motor controls e.g. washing machines and vacuum cleaners, Rectifier-fed DC inductive loads e.g. DC motors and solenoids , motor speed controllers.

### Features

- ◆ Repetitive Peak Off-State Voltage: 1200V and 1600V
- ◆ R.M.S On-State Current (  $I_{T(RMS)} = 40A$  )
- ◆ High Commutation  $dv/dt$
- ◆ These Devices are Pb-Free and are RoHS Compliant



### Absolute Maximum Ratings

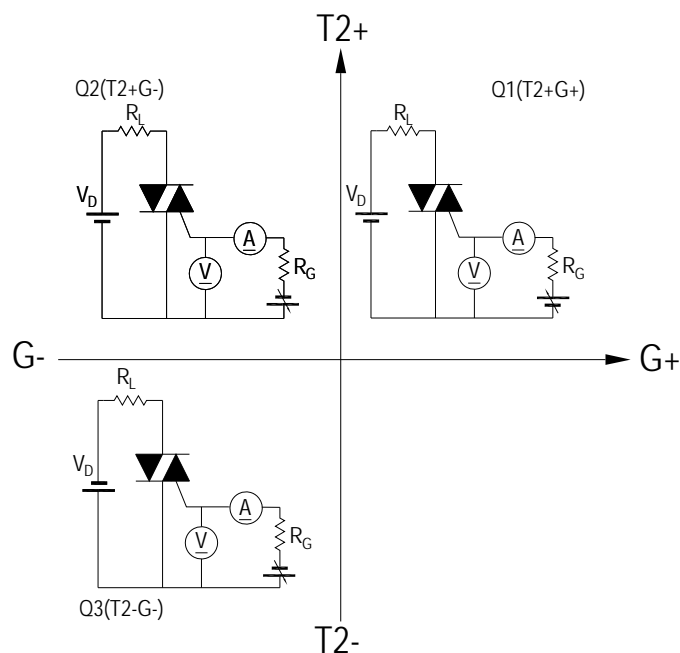
Symbol	Items	Conditions	Ratings	Unit
$V_{DRM}$ $V_{RRM}$	Repetitive Peak Off-State Voltage	$T_j = 25^\circ C$	ADS40C120X 1200 ADS40C160X 1600	V V
$I_{T(RMS)}$	R.M.S On-State Current	$T_C = 95^\circ C$	40	A
$I_{TSM}$	Surge On-State Current	$t_p = 20ms(50Hz) / t_p = 16.7ms(60Hz)$	400/420	A
$I^2t$	$I^2t$ for fusing	$t_p = 10ms$	880	$A^2s$
$di/dt$	Critical rate of rise of on-state current	$F = 120 Hz$ $T_j = 125^\circ C$ $I_G = 2 \times I_{GT}$ , $t_r \leq 100 ns$	50	$A/\mu s$
$I_{GM}$	Peak Gate Current	$t_p = 20 \mu s$ $T_j = 125^\circ C$	8	A
$P_{G(AV)}$	Average Gate Power Dissipation( $T_j = 125^\circ C$ )		1	W
$P_{GM}$	Peak Gate Power Dissipation( $t_p = 20\mu s, T_j = 125^\circ C$ )		10	W
$T_j$	Operating Junction Temperature		- 40 ~ 125	$^\circ C$
$T_{STG}$	Storage Temperature		- 40 ~ 150	$^\circ C$



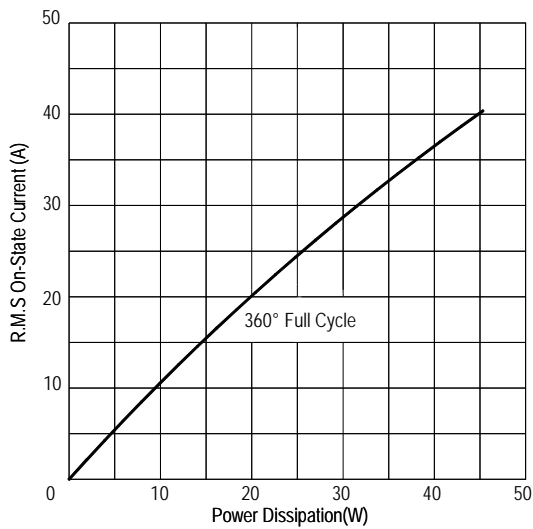
## Electrical Characteristics ( $T_j = 25^\circ\text{C}$ unless otherwise specified )

Symbol	Items		Conditions		ADS40C120XB/160XB	Unit
$I_{DRM}$	Peak Forward Reverse Blocking		$V_{DRM} = V_{RRM}, T_j = 25^\circ\text{C}$	Max.	5	$\mu\text{A}$
$I_{RRM}$	Current		$V_{DRM} = V_{RRM}, T_j = 125^\circ\text{C}$		5	$\text{mA}$
$V_{TM}$	Peak On-State Voltage		$I_{TM} = 60\text{A}, t_p = 380 \mu\text{s}$	Max.	1.55	$\text{V}$
$V_{GD}$	Q1-Q2-Q3	Non-Trigger Gate Voltage	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$ $T_j = 125^\circ\text{C}$	Min.	0.2	$\text{V}$
$V_{GT}$	Q1-Q2-Q3	Gate Trigger Voltage	$V_D = 12\text{V}, R_L = 33\Omega$	Max.	1.3	$\text{V}$
$I_{GT}$	Q1-Q2-Q3	Gate Trigger Current		Max.	50	$\text{mA}$
$I_H$	Q1-Q2-Q3	Holding Current	$I_T = 0.5\text{A}$	Max.	75	$\text{mA}$
$I_L$	Q1-Q3	Latching Current	$I_G = 1.2 I_{GT}$	Max.	90	$\text{mA}$
	Q2				110	
$dV/dt$	Critical Rate of Rise of Off-State Voltage		$V_D = 2/3 V_{DRM}$ gate open $T_j = 125^\circ\text{C}$	Min.	1500	$\text{V}/\mu\text{s}$
$(dV/dt)_c$	Critical Rate of Change of Commutating Voltage		$(dI/dt)_c = -20\text{A/ms}$ $T_j = 125^\circ\text{C}$	Min.	20	$\text{V}/\mu\text{s}$
$R_{th(j-c)}$	Junction to case (AC)			Max.	0.6	$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	Junction to ambient			Max.	50	$^\circ\text{C}/\text{W}$

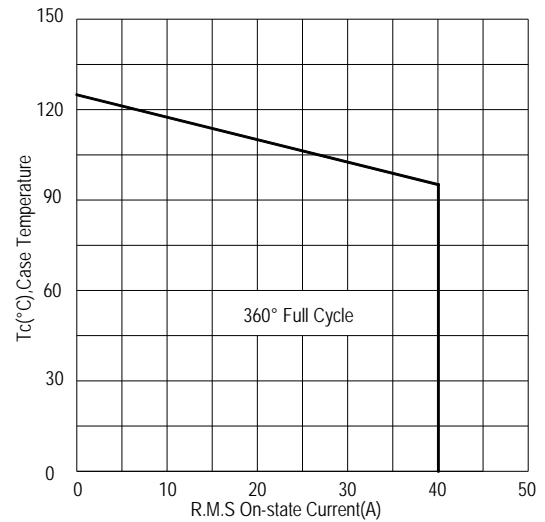
FIG.1: Triac quadrant are defined and the gate trigger test circuit



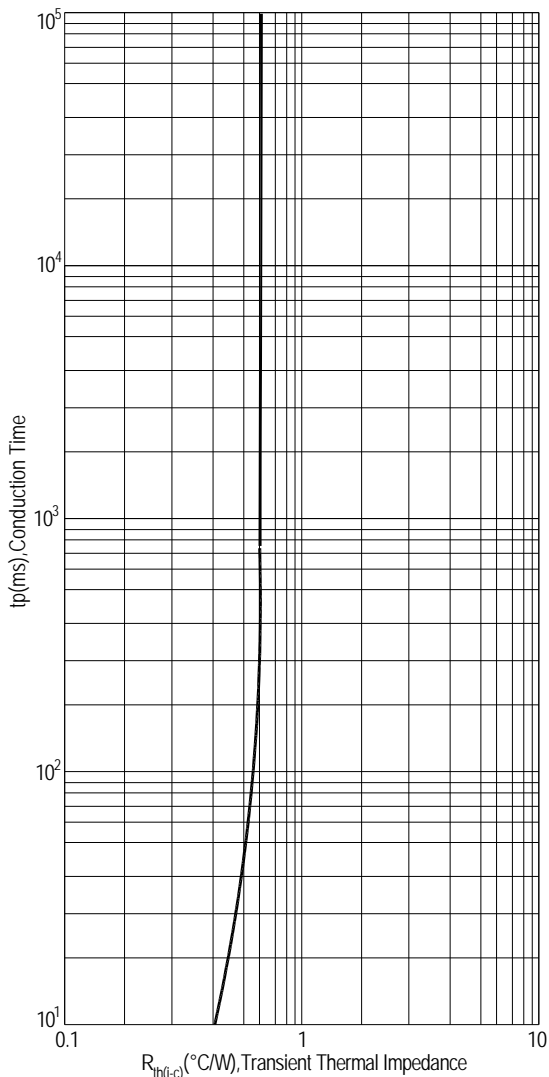
**FIG.2: Maximum on-state power dissipation**



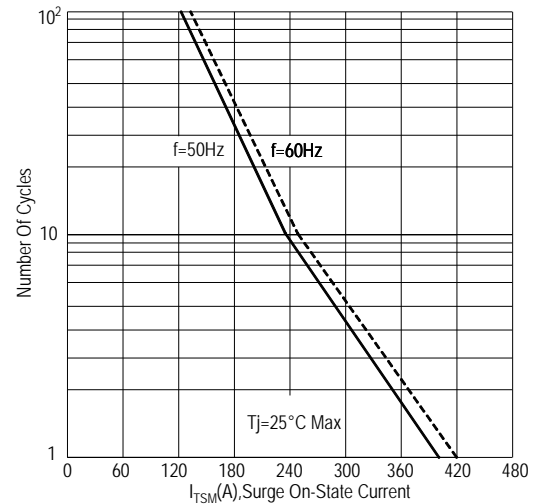
**FIG.3: Typical RMS on-state current VS Allowable case Temperature**



**FIG.4: Maximum transient thermal impedance**



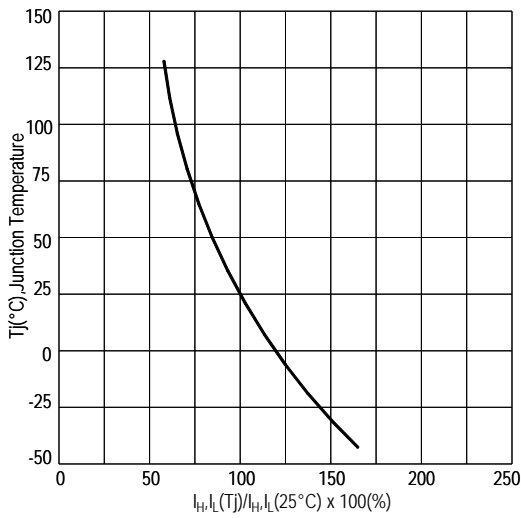
**FIG.5: Rated surge on-state current (Non-Repetitive)**



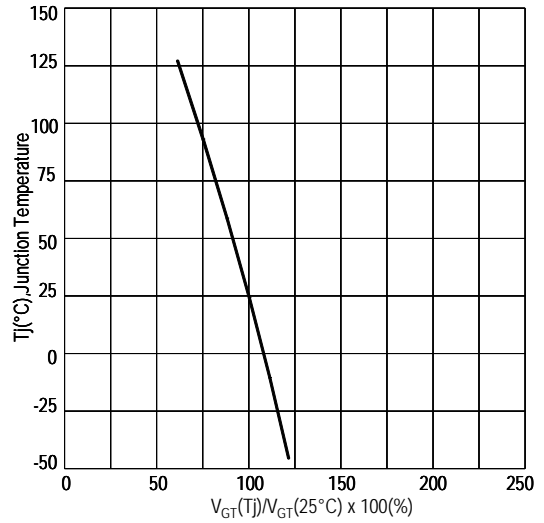
**FIG.6: Gate trigger current VS Junction temperature**



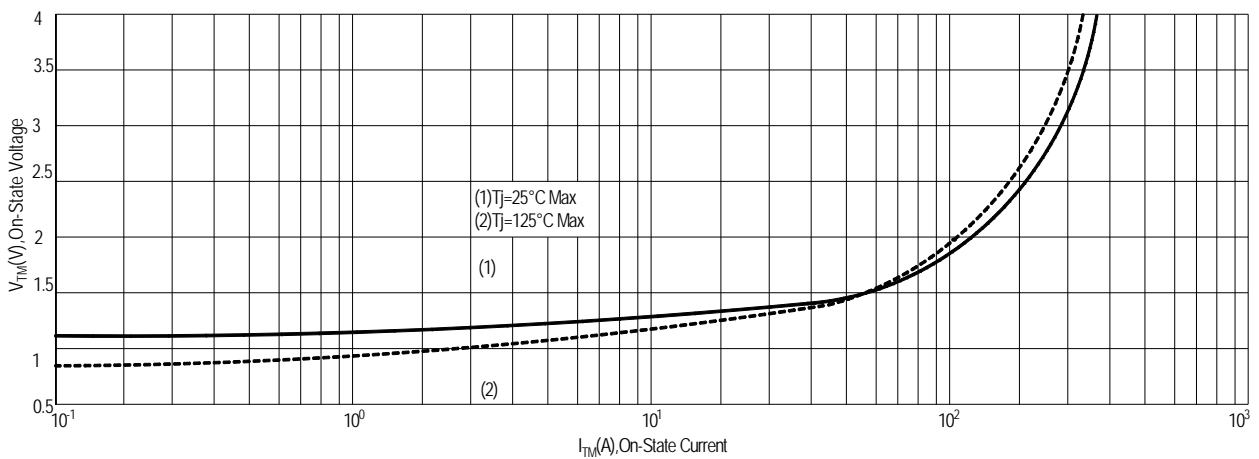
**FIG.7: Holding current and Latching current VS Junction temperature**



**FIG.8: Gate trigger voltage VS Junction temperature**

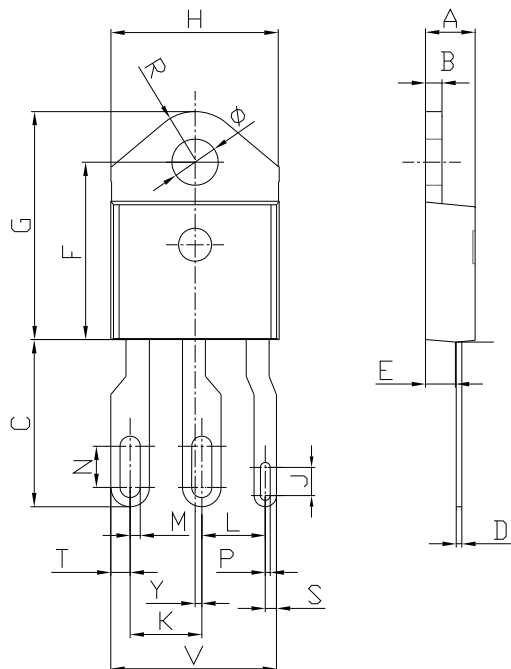


**FIG.9: On-state characteristics(Max)**



## PACKAGE MECHANICAL DATA

### TO-3PX Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.40	4.60	0.173	0.181
B	1.45	1.55	0.057	0.061
C	14.35	15.60	0.565	0.614
D	0.50	0.70	0.020	0.028
E	2.70	2.90	0.106	0.114
F	15.80	16.50	0.622	0.650
G	20.40	21.10	0.815	0.831
H	15.10	15.50	0.594	0.610
J	2.87	3.07	0.113	0.121
K	6.50	6.71	0.256	0.264
Ø	4.08	4.20	0.161	0.165
L	5.58	5.79	0.220	0.228
P	0.43	0.53	0.017	0.020
N	4.29	4.49	0.169	0.177
M	1.015	1.12	0.040	0.044
T	1.98	2.11	0.078	0.083
Y	0.71	0.81	0.028	0.032
V	15.31	15.70	0.603	0.618
S	1.09	1.22	0.086	0.096
R	4.60 typ.		0.181 typ.	

### Making Diagram

**ADV**: Logo  
**ADS40C120XB**: Part number  
**X**: Internal control code  
**H**: Halogen Free

AD S 40 C 120 X B

ADVANCED	Internal control code	Current: 40=40A	Sensitivity and type: B=50mA
Quadrant: C=3Q	Voltage: 120=1200V 160=1600V	Package explain: X=TO-3PX	

### Ordering information

Part number	Package	Marking	Packing	Quantity
ADS40C120XB	TO-3PX	ADS40C120XB	Tube	30pcs
ADS40C160XB	TO-3PX	ADS40C160XB	Tube	30pcs

Note: B = Gate Trigger Current Sensitivity and type

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